



Legislation Text

File #: FP-1718-7, **Version:** 1

CONSIDERATION OF A FINAL PLAT FOR HIGHLAND VILLAGE ADDITION, SECTION 10, AND ACCEPTANCE OF PUBLIC DEDICATIONS CONTAINED THEREIN. (GENERALLY LOCATED ONE-FOURTH MILE SOUTH OF TECUMSEH ROAD AND ONE-FOURTH MILE WEST OF PORTER AVENUE.

BACKGROUND: This item is a final plat for Highland Village Addition, Section 10, which is generally located one-quarter of a mile south of Tecumseh Road and one-quarter of a mile west of Porter Avenue.

City Council, at its meeting of March 13, 2001 adopted Ordinance O-0001-33, placing this property in R-1, Single Family Dwelling District and removing it from A-2, Rural Agricultural District. City Council approved a revised preliminary plat at its meeting of February 23, 2010. The City Development Committee, at its meeting of August 8, 2017, reviewed and approved the program of public improvements and final plat for Highland Village Addition, Section 10, and recommended that the final plat be submitted to City Council for consideration.

This property consists of 11.99 acres and thirty-two (32) single-family residential lots. The final plats of Highland Village Additions, Sections 1 through 9, consist of 359 lots. The entire development will consist of a total of 391 single-family residential lots. This final plat completes the development.

DISCUSSION: Public improvements consist of water mains with fire hydrants, sanitary sewer, drainage, street paving and sidewalk improvements. Public improvements are under construction.

Park land dedication requirements have been fulfilled.

STAFF RECOMMENDATION: The final plat is consistent with the preliminary plat. Based upon the above information, Staff recommends approval of the final plat, acceptance of the public dedication contained therein, and authorization for the Mayor to sign the final plat, subdivision bonds/cash sureties and maintenance bonds for Highland Village Addition, Section 10; subject to completion and the City Development Committee's acceptance of the public improvements or bonding of the improvements.